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MAX9312ETJ+

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19-2079; Rev 2; 4/09

Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

General Description

The MAX9312/MAX9314 are low skew, dual 1-to-5 differential drivers designed for clock and data distribution. These devices accept two inputs. Each input is reproduced at five differential outputs. The differential inputs can be adapted to accept single-ended inputs by connecting the on-chip V_{BB} supply to one input as a reference voltage.

The MAX9312/MAX9314 feature low part-to-part skew (30ps) and output-to-output skew (12ps), making them ideal for clock and data distribution across a backplane or a board. For interfacing to differential HSTL and LVPECL signals, these devices operate over a +2.25V to +3.8V supply range, allowing high-performance clock or data distribution in systems with a nominal +2.5V or +3.3V supply. For differential LVECL operation, these devices operate from a -2.25V to -3.8V supply.

The MAX9312 features an on-chip V_{BB} reference output of 1.425V below the positive supply voltage. The MAX9314 offers an on-chip V_{BB} reference output of 1.32V below the positive supply voltage.

Both devices are offered in an industry-standard 32-pin 7mm x 7mm LQFP package. In addition, the MAX9312 is offered in a space-saving 32-pin 5mm x 5mm TQFN package.

Applications

Precision Clock Distribution

Low-Jitter Data Repeater

Features

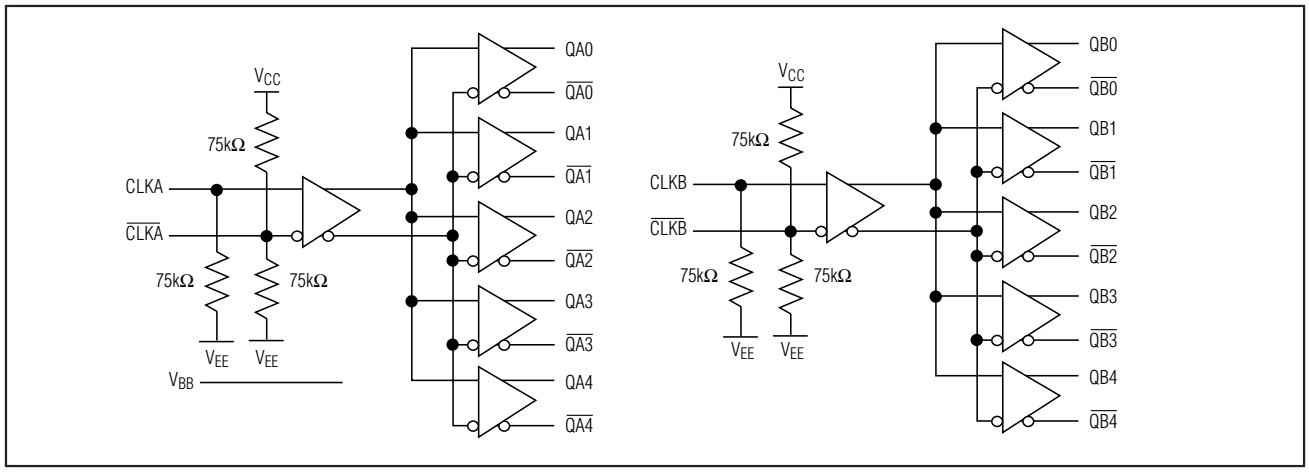
- **+2.25V to +3.8V Differential HSTL/LVPECL Operation**
- **-2.25V to -3.8V Differential LVECL Operation**
- **30ps (typ) Part-to-Part Skew**
- **12ps (typ) Output-to-Output Skew**
- **312ps (typ) Propagation Delay**
- **≥ 300mV Differential Output at 3GHz**
- **On-Chip Reference for Single-Ended Inputs**
- **Output Low with Open Input**
- **Pin Compatible with MC100LVEP210 (MAX9312) and MC100EP210 (MAX9314)**
- **Offered in Tiny QFN* Package (70% Smaller Footprint than LQFP)**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX9312ECJ+	-40°C to +85°C	32 LQFP
MAX9312ETJ+	-40°C to +85°C	32 TQFN-EP*
MAX9314ECJ	-40°C to +85°C	32 LQFP

*Exposed pad.
+Denotes a lead(Pb)-free/RoHS-compliant package.

Functional Diagram



Pin Configuration appears at end of data sheet.

Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

ABSOLUTE MAXIMUM RATINGS

V_{CC} - V_{EE} 4.1V
Inputs (CLK_, $\overline{CLK\_}$) ..... V_{EE} - 0.3V to V_{CC} + 0.3V
CLK_ to $\overline{CLK\_}$ ..... ±3.0V
Continuous Output Current 50mA
Surge Output Current 100mA
V_{BB} Sink/Source Current ..... ±0.65mA
Continuous Power Dissipation (T_A = +70°C)
32-Pin LQFP (derate 20.7mW/°C above +70°C) 1652.9mW
32-Pin TQFN (derate 34.5mW/°C above +70°C) 2758.6mW
Junction-to-Case Thermal Resistance (T_{JC}) (Note A)
32-Pin LQFP ..... 12°C/W
32-Pin TQFN ..... 2°C/W
Junction-to-Ambient Thermal Resistance (T_{JA}) (Note 1)
32-Pin LQFP ..... 48.4°C/W
32-Pin TQFN ..... 29°C/W
Operating Temperature Range ..... -40°C to +85°C
Junction Temperature ..... +150°C
Storage Temperature Range ..... -65°C to +150°C
ESD Protection
Human Body Model (CLK_, $\overline{CLK\_}$, Q_, $\overline{Q\_}$) 2kV
Soldering Temperature (10s) ..... +300°C

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maxim-ic.com/thermal-tutorial**.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{CC} - V_{EE} = +2.25V to +3.8V, outputs loaded with 50Ω ±1% to V_{CC} - 2V.) (Notes 2–5)

PARAMETER	SYMBOL	CONDITIONS		-40°C		+25°C		+85°C		UNITS
				MIN	MAX	MIN	MAX	MIN	MAX	
INPUTS (CLK_, $\overline{CLK\_}$)										
Single-Ended Input High Voltage	V_{IH}	V_{BB} connected to $\overline{CLK\_}$ (V_{IL} for V_{BB} connected to CLK_)	MAX9312	V_{CC} - 1.23	V_{CC}	V_{CC} - 1.23	V_{CC}	V_{CC} - 1.23	V_{CC}	V
			MAX9314	V_{CC} - 1.165	V_{CC}	V_{CC} - 1.165	V_{CC}	V_{CC} - 1.165	V_{CC}	
Single-Ended Input Low Voltage	V_{IL}	V_{BB} connected to $\overline{CLK\_}$ (V_{IL} for V_{BB} connected to CLK_)	MAX9312	V_{EE}	V_{CC} - 1.62	V_{EE}	V_{CC} - 1.62	V_{EE}	V_{CC} - 1.62	V
			MAX9314	V_{EE}	V_{CC} - 1.475	V_{EE}	V_{CC} - 1.475	V_{EE}	V_{CC} - 1.475	
High Voltage of Differential Input	V_{IHD}			V_{EE} + 1.2	V_{CC}	V_{EE} + 1.2	V_{CC}	V_{EE} + 1.2	V_{CC}	V
Low Voltage of Differential Input	V_{ILD}			V_{EE}	V_{CC} - 0.095	V_{EE}	V_{CC} - 0.095	V_{EE}	V_{CC} - 0.095	V
Differential Input Voltage	V_{IHD} - V_{ILD}	For V_{CC} - V_{EE} < 3.0V		0.095	V_{CC} - V_{EE}	0.095	V_{CC} - V_{EE}	0.095	V_{CC} - V_{EE}	V
		For V_{CC} - V_{EE} ≥ 3.0V		0.095	3.0	0.095	3.0	0.095	3.0	
Input High Current	I_{IH}				150		150		150	µA
CLK_ Input Low Current	I_{ILCLK}			-10	+10	-10	+10	-10	+10	µA

DC ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} - V_{EE} = +2.25V to +3.8V, outputs loaded with 50Ω ±1% to V_{CC} - 2V.) (Notes 2–5)

PARAMETER	SYMBOL	CONDITIONS		-40°C		+25°C		+85°C		UNITS
				MIN	MAX	MIN	MAX	MIN	MAX	
$\overline{CLK}$_ Input Low Current	$I_{IL\overline{CLK}}$			-150		-150		-150		µA
OUTPUTS (Q__, $\overline{Q}$__)										
Single-Ended Output High Voltage	V_{OH}	Figure 1		V_{CC} - 1.025	V_{CC} - 0.900	V_{CC} - 1.025	V_{CC} - 0.900	V_{CC} - 1.025	V_{CC} - 0.900	V
Single-Ended Output Low Voltage	V_{OL}	Figure 1		V_{CC} - -1.930	V_{CC} - 1.695	V_{CC} - -1.930	V_{CC} - 1.695	V_{CC} - -1.930	V_{CC} - 1.695	V
Differential Output Voltage	V_{OH} - V_{OL}	Figure 1		670	950	670	950	670	950	mV
REFERENCE (V_{BB})										
Reference Voltage Output (Note 6)	V_{BB}	I_{BB} = ±0.5mA	MAX9312	V_{CC} - 1.525	V_{CC} - 1.325	V_{CC} - 1.525	V_{CC} - 1.325	V_{CC} - 1.525	V_{CC} - 1.325	V
			MAX9314	V_{CC} - 1.38	V_{CC} - 1.26	V_{CC} - 1.38	V_{CC} - 1.26	V_{CC} - 1.38	V_{CC} - 1.26	
POWER SUPPLY										
Supply Current (Note 7)	I_{EE}				75		82		95	mA

Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

AC ELECTRICAL CHARACTERISTICS

(V_{CC} - V_{EE} = +2.25V to +3.8V, outputs loaded with 50Ω ±1% to V_{CC} - 2V, input frequency = 1.5GHz, input transition time = 125ps (20% to 80%), V_{IHD} = V_{EE} + 1.2V to V_{CC}, V_{ILD} = V_{EE} to V_{CC} - 0.15V, V_{IHD} - V_{ILD} = 0.15V to the smaller of 3V or V_{CC} - V_{EE}, unless otherwise noted. Typical values are at V_{CC} - V_{EE} = 3.3V, V_{IHD} = V_{CC} - 1V, V_{ILD} = V_{CC} - 1.5V.) (Note 8)

PARAMETER	SYMBOL	CONDITIONS	-40°C			+25°C			+85°C			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
Differential Input-to-Output Delay	t_{PLHD}, t_{PHLD}	Figure 2	220	321	380	220	312	410	260	322	400	ps
Output-to-Output Skew (Note 9)	t_{SKOO}			12	46		12	46		10	35	ps
Part-to-Part Skew (Note 10)	t_{SKPP}			30	160		30	190		30	140	ps
Added Random Jitter (Note 11)	t_{RJ}	f_{IN} = 1.5GHz clock pattern		1.2	2.5		1.2	2.5		1.2	2.5	ps (RMS)
		f_{IN} = 3.0GHz clock pattern		1.2	2.6		1.2	2.6		1.2	2.6	
Added Deterministic Jitter (Note 11)	t_{DJ}	3Gbps, 2^{23} -1 PRBS pattern		80	95		80	95		80	95	ps (pk-pk)
Switching Frequency	f_{MAX}	V_{OH} - V_{OL} ≥ 300mV, clock pattern, Figure 2		3.0			3.0			3.0		GHz
		V_{OH} - V_{OL} ≥ 500mV, clock pattern, Figure 2	1.5			1.5			1.5			
Output Rise/Fall Time (20% to 80%)	t_R, t_F	Figure 2	100	112	140	100	116	140	100	121	140	ps

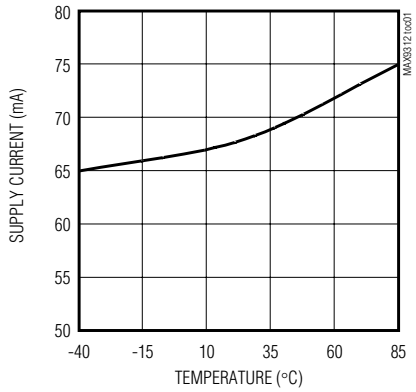
Note 2: Measurements are made with the device in thermal equilibrium.
Note 3: Current into a pin is defined as positive. Current out of a pin is defined as negative.
Note 4: Single-ended input operation using V_{BB} is limited to V_{CC} - V_{EE} = 3.0V to 3.8V for the MAX9312 and V_{CC} - V_{EE} = 2.7V to 3.8V for the MAX9314.
Note 5: DC parameters production tested at T_A = +25°C. Guaranteed by design and characterization over the full operating temperature range.
Note 6: Use V_{BB} only for inputs that are on the same device as the V_{BB} reference.
Note 7: All pins open except V_{CC} and V_{EE}.
Note 8: Guaranteed by design and characterization limits are set at ±6 sigma.
Note 9: Measured between outputs on the same part at the signal crossing points for a same-edge transition.
Note 10: Measured between outputs of different parts at the signal crossing points under identical conditions for a same-edge transition.
Note 11: Device jitter added to the input signal.

Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

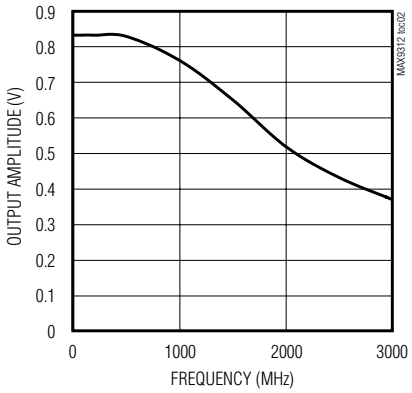
Typical Operating Characteristics

(V_{CC} = +3.3V, V_{EE} = 0, V_{IHD} = V_{CC} - 0.95V, V_{ILD} = V_{CL} - 1.25V, input transition time = 125ps (20% to 80%), f_{IN} = 1.5GHz, outputs loaded with 50Ω to V_{CC} - 2V, T_A = +25°C, unless otherwise noted.)

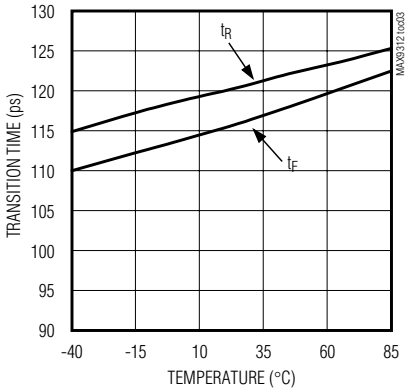
SUPPLY CURRENT, I_{EE} vs. TEMPERATURE



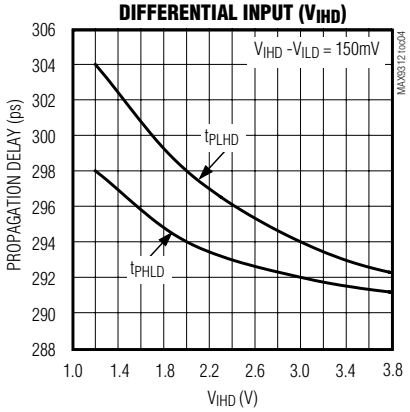
OUTPUT AMPLITUDE (V_{OH} - V_{OL}) vs. FREQUENCY



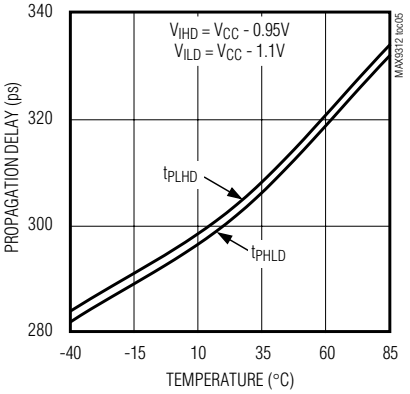
TRANSITION TIME vs. TEMPERATURE



PROPAGATION DELAY vs. SINGLE-ENDED HIGH VOLTAGE OF DIFFERENTIAL INPUT (V_{IHD})



PROPAGATION DELAY vs. TEMPERATURE



Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

Pin Description

PIN	NAME	FUNCTION
1, 9, 16, 25, 32	V_{CC}	Positive Supply Voltage. Bypass from V_{CC} to V_{EE} with 0.1µF and 0.01µF ceramic capacitors. Place the capacitors as close to the device as possible with the smaller value capacitor closest to the device.
2	N.C.	No Connection. Internally not connected.
3	CLKA	Noninverting Differential Clock Input A
4	$\overline{CLKA}$	Inverting Differential Clock Input A
5	V_{BB}	Reference Output Voltage. Connect to the inverting or noninverting clock input to provide a reference for single-ended operation. When used, bypass to V_{CC} with a 0.01µF ceramic capacitor.
6	CLKB	Noninverting Differential Clock Input B
7	$\overline{CLKB}$	Inverting Differential Clock Input B
8	V_{EE}	Negative Supply Voltage
10	$\overline{QB4}$	Inverting QB4 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
11	QB4	Noninverting QB4 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
12	$\overline{QB3}$	Inverting QB3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
13	QB3	Noninverting QB3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
14	$\overline{QB2}$	Inverting QB2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
15	QB2	Noninverting QB2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
17	$\overline{QB1}$	Inverting QB1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
18	QB1	Noninverting QB1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
19	$\overline{QB0}$	Inverting QB0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
20	QB0	Noninverting QB0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
21	$\overline{QA4}$	Inverting QA4 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
22	QA4	Noninverting QA4 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
23	$\overline{QA3}$	Inverting QA3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
24	QA3	Noninverting QA3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
26	$\overline{QA2}$	Inverting QA2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
27	QA2	Noninverting QA2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
28	$\overline{QA1}$	Inverting QA1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
29	QA1	Noninverting QA1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
30	$\overline{QA0}$	Inverting QA0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
31	QA0	Noninverting QA0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
—	EP	Exposed Pad (TQFN package only). Internally connected to V_{EE}. Connect EP to the V_{EE} pad on the PCB.

Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

Detailed Description

The MAX9312/MAX9314 are low-skew, dual 1-to-5 differential drivers designed for clock and data distribution.

For interfacing to differential HSTL and LVPECL signals, these devices operate over a +2.25V to +3.8V supply range, allowing high-performance clock or data distribution in systems with a nominal +2.5V or +3.3V supply. For differential LVECL operation, these devices operate from a -2.25V to -3.8V supply.

The differential inputs can be configured to accept single-ended inputs when operating at approximately V_{CC} - V_{EE} = 3.0V to 3.8V for the MAX9312 or V_{CC} - V_{EE} = 2.7V to 3.8V for the MAX9314. This is accomplished by connecting the on-chip reference voltage, V_{BB}, to an input as a reference. For example, the differential CLKA, $\overline{CLKA}$ input is converted to a noninverting, single-ended input by connecting V_{BB} to $\overline{CLKA}$ and connecting the single-ended input to CLKA. Similarly, an inverting input is obtained by connecting V_{BB} to CLKA and connecting the single-ended input to $\overline{CLKA}$. With a differential input configured as single ended (using V_{BB}), the single-ended input can be driven to V_{CC} and V_{EE} or with a single-ended LVPECL/LVECL signal.

When a differential input is configured as a single-ended input (using V_{BB}), the approximate supply range is V_{CC} - V_{EE} = 3.0V to 3.8V for the MAX9312 and V_{CC} - V_{EE} = 2.7V to 3.8V for the MAX9314. This is because one of the inputs must be V_{EE} + 1.2V or higher for proper operation of the input stage. V_{BB} must be at least V_{EE} + 1.2V because it becomes the high-level input when the other (single-ended) input swings below it. Therefore, minimum V_{BB} = V_{EE} + 1.2V.

The minimum V_{BB} output for the MAX9312 is V_{CC} - 1.525V and the minimum V_{BB} output for the MAX9314 is V_{CC} - 1.38V. Substituting the minimum V_{BB} output for each device into V_{BB} = V_{EE} + 1.2V results in a minimum supply of 2.725V for the MAX9312 and 2.58V for the MAX9314. Rounding up to standard supplies gives the single-ended operating supply ranges of V_{CC} - V_{EE} = 3.0V to 3.8V for the MAX9312 and V_{CC} - V_{EE} = 2.7V to 3.8V for the MAX9314.

When using the V_{BB} reference output, bypass it with a 0.01µF ceramic capacitor to V_{CC}. If the V_{BB} reference is not used, it can be left open. The V_{BB} reference can source or sink 0.5mA, which is sufficient to drive two inputs. Use V_{BB} only for inputs that are on the same device as the V_{BB} reference.

The maximum magnitude of the differential input from CLK_ to $\overline{CLK\_}$ is 3.0V or V_{CC} - V_{EE}, whichever is less. This limit also applies to the difference between any reference voltage input and a single-ended input.

The differential inputs have bias resistors that drive the outputs to a differential low when the inputs are open. The inverting inputs ($\overline{CLKA}$ and $\overline{CLKB}$) are biased with a 75kΩ pullup to V_{CC} and a 75kΩ pulldown to V_{EE}. The noninverting inputs (CLKA and CLKB) are biased with a 75kΩ pulldown to V_{EE}.

Specifications for the high and low voltages of a differential input (V_{IHD} and V_{ILD}) and the differential input voltage (V_{IHD} - V_{ILD}) apply simultaneously (V_{ILD} cannot be higher than V_{IHD}).

Output levels are referenced to V_{CC} and are considered LVPECL or LVECL, depending on the level of the V_{CC} supply. With V_{CC} connected to a positive supply and V_{EE} connected to GND, the outputs are LVPECL. The outputs are LVECL when V_{CC} is connected to GND and V_{EE} is connected to a negative supply.

A single-ended input of at least V_{BB} ±95mV or a differential input of at least 95mV switches the outputs to the V_{OH} and V_{OL} levels specified in the *DC Electrical Characteristics* table.

Applications Information

Supply Bypassing

Bypass V_{CC} to V_{EE} with high-frequency surface-mount ceramic 0.1µF and 0.01µF capacitors in parallel as close to the device as possible, with the 0.01µF value capacitor closest to the device. Use multiple parallel vias for low inductance. When using the V_{BB} reference output, bypass it with a 0.01µF ceramic capacitor to V_{CC} (if the V_{BB} reference is not used, it can be left open).

Traces

Input and output trace characteristics affect the performance of the MAX9312/MAX9314.

Connect each signal of a differential input or output to a 50Ω characteristic impedance trace. Minimize the number of vias to prevent impedance discontinuities. Reduce reflections by maintaining the 50Ω characteristic impedance through connectors and across cables. Reduce skew within a differential pair by matching the electrical length of the traces.

Output Termination

Terminate outputs through 50Ω to V_{CC} - 2V or use an equivalent Thevenin termination. When a single-ended signal is taken from a differential output, terminate both outputs. For example, if QA0 is used as a single-ended output, terminate both QA0 and $\overline{QA0}$.

Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

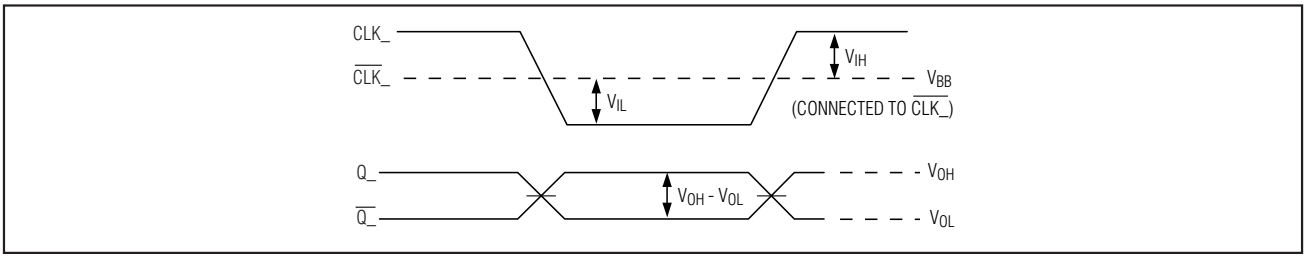


Figure 1. Switching with Single-Ended Input

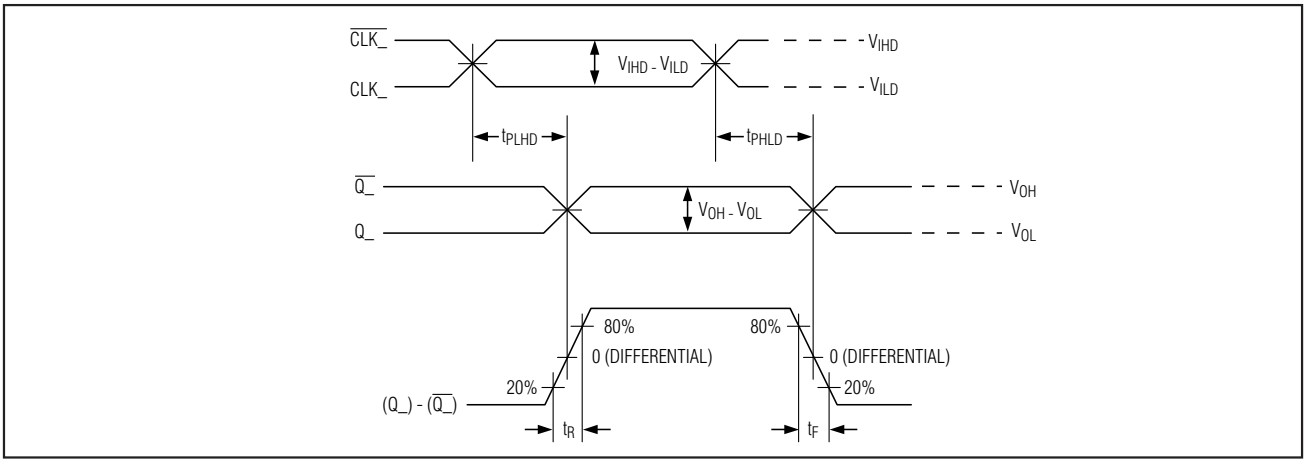
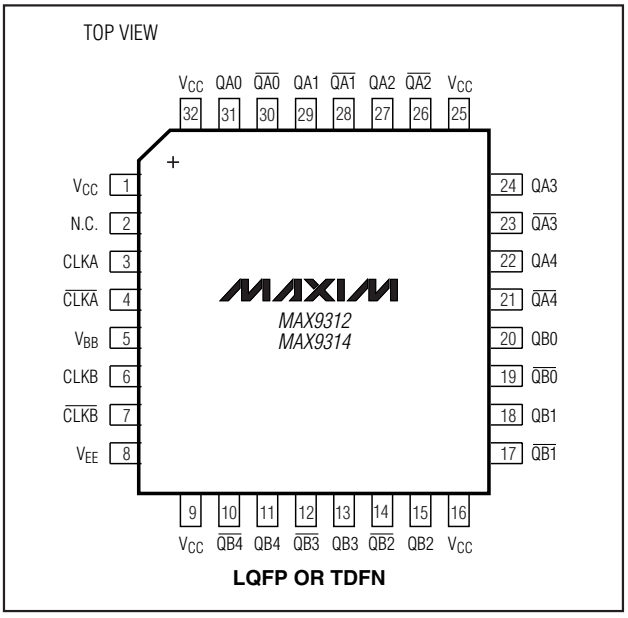


Figure 2. Differential Transition Time and Propagation Delay Timing Diagram

Pin Configuration



Chip Information

PROCESS: BIPOLAR

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
32 LQFP	C32-1	21-0054
12 TQFN-EP	T3255+4	21-0140

Dual 1:5 Differential LVPECL/LVECL/HSTL Clock and Data Drivers

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	4/09	Added lead-free TQFN package for MAX9312, deleted future product packages for MAX9314, and updated *Pin Description*	1, 6